504613594 10/26/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4660307

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KWAN HO KIM	10/20/2017
JIN HEE PARK	10/20/2017
HO SEOK SON	10/20/2017
SUNG YEON CHO	10/20/2017
JAE HYUNG CHO	10/20/2017
HYUN JAE NA	10/20/2017

RECEIVING PARTY DATA

Name:	SAMSUNG DISPLAY CO., LTD.
Street Address:	1, SAMSUNG-RO, GIHEUNG-GU
Internal Address:	GYEONGGI-DO
City:	YONGIN-SI
State/Country:	KOREA, REPUBLIC OF

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15794829

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: H.C. PARK & ASSOCIATES

Correspondent Name: H.C. PARK & ASSOCIATES, PLC Address Line 1: 1894 PRESTON WHITE DRIVE

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ATTORNEY DOCKET NUMBER:	P7391US00
NAME OF SUBMITTER:	HAE-CHAN PARK
SIGNATURE:	/Hae-Chan Park/
DATE SIGNED:	10/26/2017
	This document serves as an Oath/Declaration (37 CFR 1.63).

PATENT REEL: 044302 FRAME: 0374

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Total Attachments: 4

source=P7391US00 Executed Assignment serving as Declaration#page1.tif source=P7391US00 Executed Assignment serving as Declaration#page2.tif source=P7391US00 Executed Assignment serving as Declaration#page3.tif source=P7391US00 Executed Assignment serving as Declaration#page4.tif

PATENT REEL: 044302 FRAME: 0375



ASSIGNMENT SERVING AS DECLARATION PER 37 C.F.R. § 1.63(e)

As a below named inventor and Assignor, I declare that:

This assignment and declaration are directed to:

DEMOE HAY	The attached application entitled TOUC ING THE SAME having attorney docket	
("Application"), which claims priority from:	
Korean Pate	nt Application No. <u>10-2016-0153979</u> , filed	1 <u>November 18, 2015</u>
	As amended on	(if applicable)
The above-id	entified Application was made or authori	zed to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the Application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in the Application,

Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to

Samsung Display Co., Ltd. 1, Samsung-ro, Giheung-gu Yongin-si Gyeonggi-do Republic of Korsa

Samsung Display Co., Ltd. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration. Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

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Fig. 8. 2.1.24079177Pissiscimo 8.8.6/Dubio. 1988.14488.

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Docket No. P7391US00

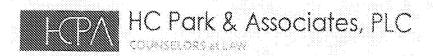
Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

First Inventor's and Assignor's Name:	Kwan Ho KIM
Address:	1, Samsung-ro, Giheung-gu Yongin-si Gyeonggi-do Republic of Korea
First Inventor's and Assignor's Signature	
Date	2011.10 50
Second Inventor's and Assignor's Name:	
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Second Inventor's and Assignor's Signature:	<u> </u>
Date:	>011 10·20

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Third Inventor's and Assignor's Name:

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Third Inventor's and Assignor's Signature	He Seak Son
Date:	7011).10,20
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Fourth Inventor's and Assignor's Signature:	240
Date:	>~!/\.10.30
Fifth Inventor's and Assignor's Name	Jae Hyung CHO
Address	1, Samsung-ro, Giheung-gu Yongin-si Gyeonggi-do Republic of Korea
Fifth Inventor's and Assignor's Signature:	<u>고 계 퀑</u>
Date	>011,10,20

Ho Seok SON

법무법인 세종_LO-201608-116-1-USD



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Hyun Jae NA

Address:

1, Samsung-ro, Giheung-gu

2011, 110 c 20

Yongin-si Gyeonggi-do Republic of Korea

Sixth Inventor's and Assignor's Signature:

Date:

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